

# NSI50350ADT4G

## Constant Current Regulator & LED Driver

50 V, 350 mA ± 10%, 11 W Package

The linear constant current regulator (CCR) is a simple, economical and robust device designed to provide a cost-effective solution for regulating current in LEDs. The CCR is based on Self-Biased Transistor (SBT) technology and regulates current over a wide voltage range. It is designed with a negative temperature coefficient to protect LEDs from thermal runaway at extreme voltages and currents.

The CCR turns on immediately and is at 20% of regulation with only 0.5 V  $V_{AK}$ . It requires no external components allowing it to be designed as a high or low-side regulator. The high anode-cathode voltage rating withstands surges common in Automotive, Industrial and Commercial Signage applications. The CCR comes in thermally robust packages and is qualified to AEC-Q101 standard and UL94-V0 Certified.

Also available in SMC: NSI50350AST3G.

### Features

- Robust Power Package: 11 W
- Wide Operating Voltage Range
- Immediate Turn-On
- Voltage Surge Suppressing – Protecting LEDs
- UL94-V0 Certified
- SBT (Self-Biased Transistor) Technology
- Negative Temperature Coefficient
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### Typical Applications

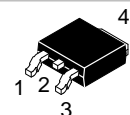
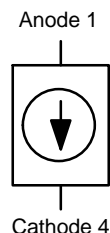
- Automobile: Chevron Side Mirror Markers, Cluster, Display & Instrument Backlighting, CHMSL, Map Light
- AC Lighting Panels, Display Signage, Decorative Lighting, Channel Lettering
- Application Note AND8349/D – Automotive CHMSL
- Application Notes AND8391/D, AND9008/D – Power Dissipation Considerations



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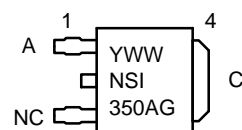
<http://onsemi.com>

$I_{reg(SS)} = 350 \text{ mA}$   
@  $V_{AK} = 7.5 \text{ V}$



DPAK  
CASE 369C

### MARKING DIAGRAM



Y = Year  
WW = Work Week  
NSI350A = Specific Device Code  
G = Pb-Free Package

### ORDERING INFORMATION

Device	Package	Shipping†
NSI50350ADT4G	DPAK (Pb-Free)	2500 / Tape & Reel
NSV50350ADT4G	DPAK (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NSI50350ADT4G

## MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Anode-Cathode Voltage	$V_{AK\text{ Max}}$	50	V
Reverse Voltage	$V_R$	500	mV
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +175	$^\circ\text{C}$
ESD Rating: Human Body Model Machine Model	ESD	Class 3B (8000 V) Class C (400 V)	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Steady State Current @ $V_{AK} = 7.5\text{ V}$ (Note 1)	$I_{reg(SS)}$	315	350	385	mA
Voltage Overhead (Note 2)	$V_{overhead}$		1.8		V
Pulse Current @ $V_{AK} = 7.5\text{ V}$ (Note 3)	$I_{reg(P)}$	376.5	424	474.5	mA

- $I_{reg(SS)}$  steady state is the voltage ( $V_{AK}$ ) applied for a time duration  $\geq 300$  sec, using 900 mm<sup>2</sup> DENKA K1, 1.5 mm Al, 2kV Thermally conductive dielectric, 2 oz. Cu (or equivalent), in still air.
- $V_{overhead} = V_{in} - V_{LEDs}$ .  $V_{overhead}$  is typical value for 70%  $I_{reg(SS)}$ .
- $I_{reg(P)}$  non-repetitive pulse test. Pulse width  $t \leq 360\ \mu\text{sec}$ .

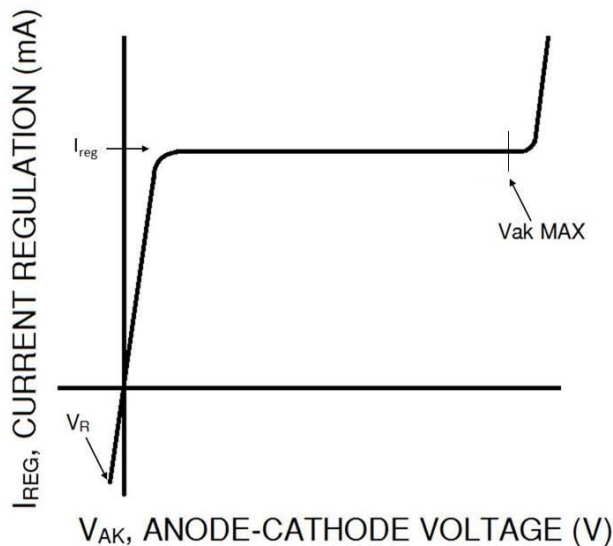


Figure 1. CCR Voltage-Current Characteristic

# NSI50350ADT4G

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation (Note 4) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	4144 27.62	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient (Note 4)	$R_{\theta JA}$	36.2	$^\circ\text{C/W}$
Thermal Reference, Junction-to-Tab (Note 4)	$R_{\psi JL}$	1.16	$^\circ\text{C/W}$
Total Device Dissipation (Note 5) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	6383 42.6	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient (Note 5)	$R_{\theta JA}$	23.5	$^\circ\text{C/W}$
Thermal Reference, Junction-to-Tab (Note 5)	$R_{\psi JL}$	1.07	$^\circ\text{C/W}$
Total Device Dissipation (Note 6) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	8671 57.8	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient (Note 6)	$R_{\theta JA}$	17.3	$^\circ\text{C/W}$
Thermal Reference, Junction-to-Tab (Note 6)	$R_{\psi JL}$	0.76	$^\circ\text{C/W}$
Total Device Dissipation (Note 7) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	11029 73.5	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient (Note 7)	$R_{\theta JA}$	13.6	$^\circ\text{C/W}$
Thermal Reference, Junction-to-Tab (Note 7)	$R_{\psi JL}$	0.72	$^\circ\text{C/W}$
Total Device Dissipation (Note 8) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	4202 28.01	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient (Note 8)	$R_{\theta JA}$	35.7	$^\circ\text{C/W}$
Thermal Reference, Junction-to-Tab (Note 8)	$R_{\psi JL}$	5.4	$^\circ\text{C/W}$

NOTE: Lead measurements are made by non-contact methods such as IR with treated surface to increase emissivity to 0.9.

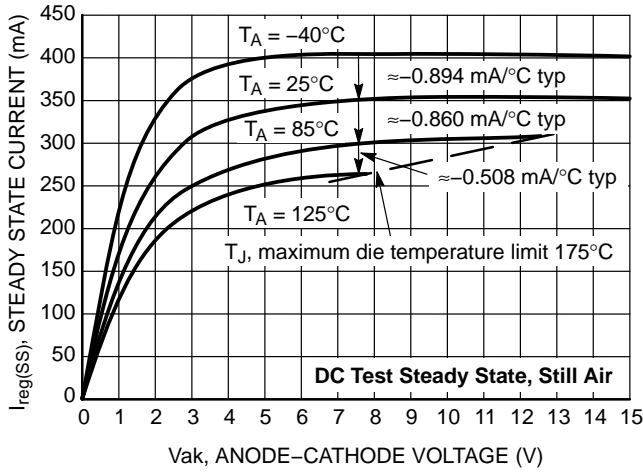
Lead temperature measurement by attaching a T/C may yield values as high as 30% higher  $^\circ\text{C/W}$  values based upon empirical measurements and method of attachment.

4. 400 mm<sup>2</sup>, see below PCB description, still air.
  5. 900 mm<sup>2</sup>, see below PCB description, still air.
  6. 1600 mm<sup>2</sup>, see below PCB description, still air.
  7. 2500 mm<sup>2</sup>, see below PCB description, still air.
- (For NOTES 4–7: PCB is DENKA K1, 1.5 mm Al, 2kV Thermally conductive dielectric, 2 oz. Cu, or equivalent).
8. 1000 mm<sup>2</sup>, FR4, 3 oz Cu, still air.

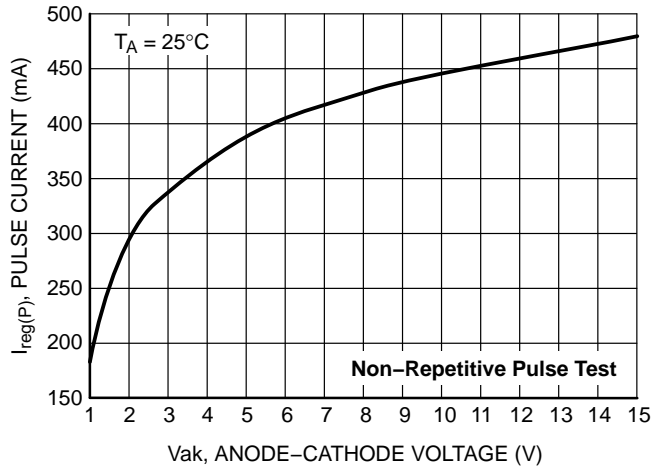
# NSI50350ADT4G

## TYPICAL PERFORMANCE CURVES

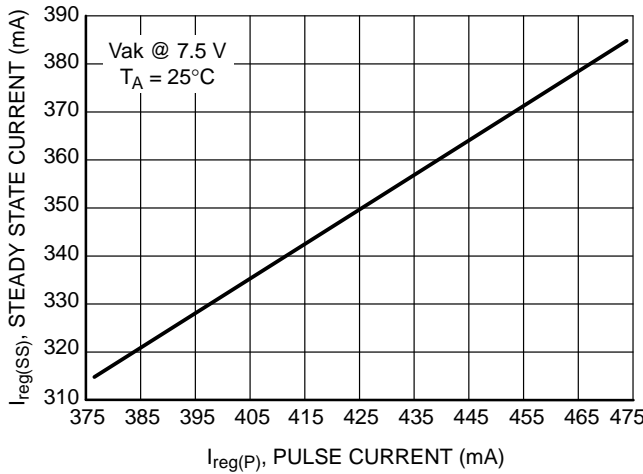
(Minimum DENKA K1 @ 900 mm<sup>2</sup>, 1.5 mm Al, 2kV Thermally conductive dielectric, 2 oz. Cu, or equivalent)



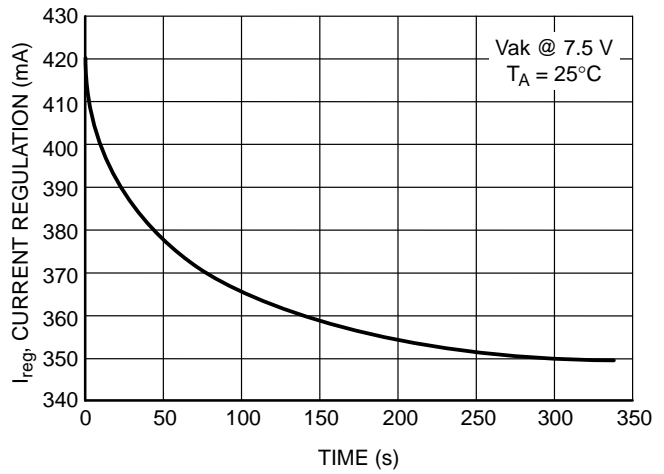
**Figure 2. Steady State Current ( $I_{reg(SS)}$ ) vs. Anode-Cathode Voltage ( $V_{ak}$ )**



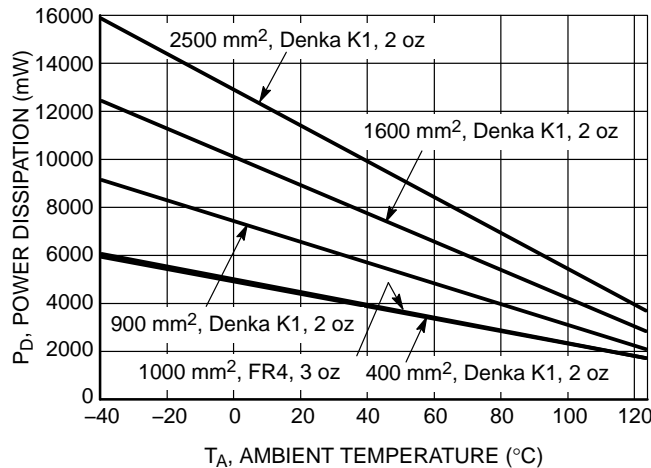
**Figure 3. Pulse Current ( $I_{reg(P)}$ ) vs. Anode-Cathode Voltage ( $V_{ak}$ )**



**Figure 4. Steady State Current vs. Pulse Current Testing**



**Figure 5. Current Regulation vs. Time**



**Figure 6. Power Dissipation vs. Ambient Temperature @  $T_J = 175^\circ\text{C}$**

APPLICATIONS INFORMATION

The CCR is a self biased transistor designed to regulate the current through itself and any devices in series with it. The device has a slight negative temperature coefficient, as shown in Figure 2 – Tri Temp. (i.e. if the temperature increases the current will decrease). This negative temperature coefficient will protect the LEDs by reducing the current as temperature rises.

The CCR turns on immediately and is typically at 20% of regulation with only 0.5 V across it.

The device is capable of handling voltage for short durations of up to 50 V so long as the die temperature does not exceed 175°C. The determination will depend on the thermal pad it is mounted on, the ambient temperature, the pulse duration, pulse shape and repetition.

**Single LED String**

The CCR can be placed in series with LEDs as a High Side or a Low Side Driver. The number of the LEDs can vary from one to an unlimited number. The designer needs to calculate the maximum voltage across the CCR by taking the maximum input voltage less the voltage across the LED string (Figures 7 and 8).



Figure 7.



Figure 8.

**Higher Current LED Strings**

Two or more fixed current CCRs can be connected in parallel. The current through them is additive (Figure 9).

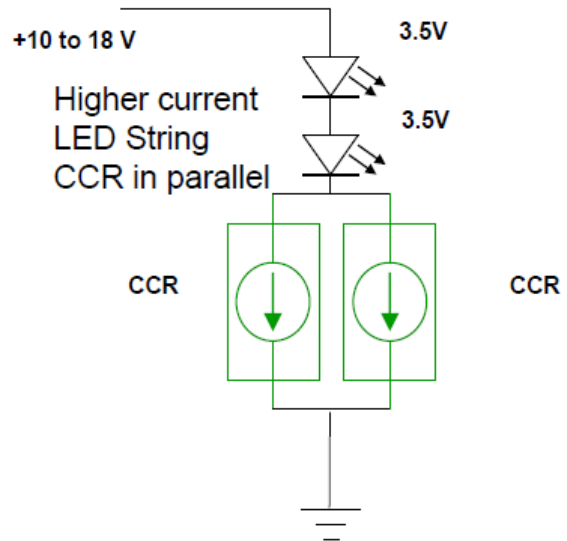


Figure 9.

**Other Currents**

The adjustable CCR can be placed in parallel with any other CCR to obtain a desired current. The adjustable CCR provides the ability to adjust the current as LED efficiency increases to obtain the same light output (Figure 10).

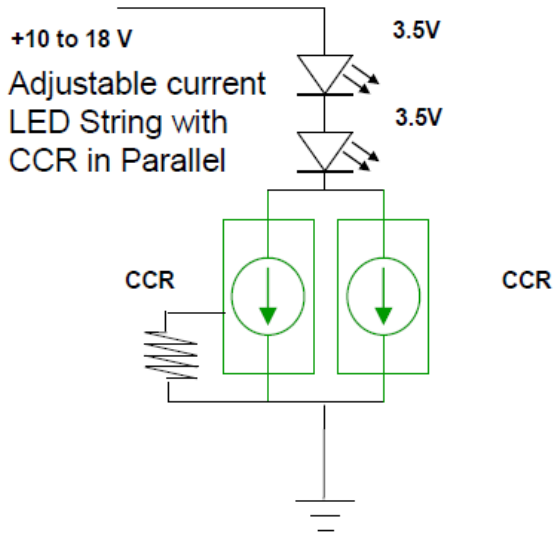


Figure 10.

**Dimming using PWM**

The dimming of an LED string can be easily achieved by placing a BJT in series with the CCR (Figure 11).

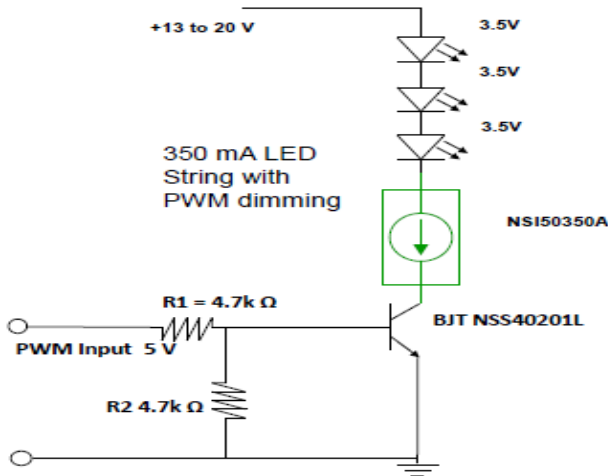


Figure 11.

The method of pulsing the current through the LEDs is known as Pulse Width Modulation (PWM) and has become the preferred method of changing the light level. LEDs being a silicon device, turn on and off rapidly in response to the current through them being turned on and off. The switching time is in the order of 100 nanoseconds, this equates to a maximum frequency of 10 MHz, and applications will typically operate from a 100 Hz to 100 kHz. Below 100 Hz the human eye will detect a flicker from the light emitted from the LEDs. Between 500 Hz and 20 kHz the circuit may

generate audible sound. Dimming is achieved by turning the LEDs on and off for a portion of a single cycle. This on/off cycle is called the Duty cycle (D) and is expressed by the amount of time the LEDs are on (Ton) divided by the total time of an on/off cycle (Ts) (Figure 12).

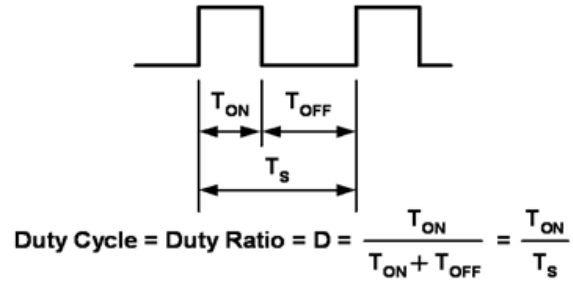


Figure 12.

The current through the LEDs is constant during the period they are turned on resulting in the light being consistent with no shift in chromaticity (color). The brightness is in proportion to the percentage of time that the LEDs are turned on.

Figure 13 is a typical response of Luminance vs Duty Cycle.

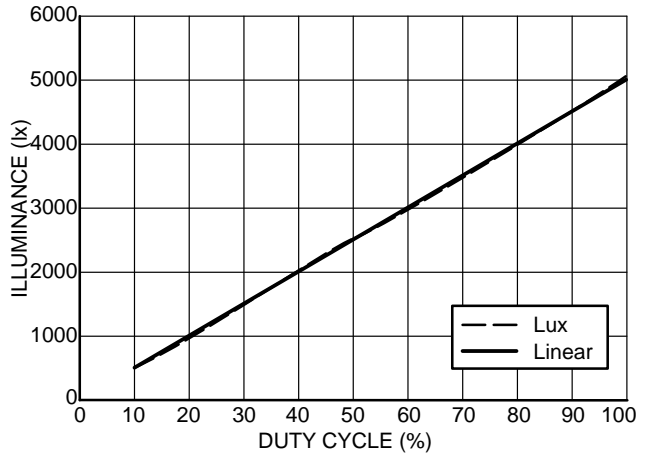


Figure 13. Luminous Emittance vs. Duty Cycle

**Reducing EMI**

Designers creating circuits switching medium to high currents need to be concerned about Electromagnetic Interference (EMI). The LEDs and the CCR switch extremely fast, less than 100 nanoseconds. To help eliminate EMI, a capacitor can be added to the circuit across R2. (Figure 11) This will cause the slope on the rising and falling edge on the current through the circuit to be extended. The slope of the CCR on/off current can be controlled by the values of R1 and C1.

The selected delay / slope will impact the frequency that is selected to operate the dimming circuit. The longer the delay, the lower the frequency will be. The delay time should not be less than a 10:1 ratio of the minimum on time. The frequency is also impacted by the resolution and dimming steps that are required. With a delay of 1.5 microseconds on the rise and the fall edges, the minimum on time would be 30 microseconds. If the design called for a resolution of 100 dimming steps, then a total duty cycle time (Ts) of 3 milliseconds or a frequency of 333 Hz will be required.

**Thermal Considerations**

As power in the CCR increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. When the device has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power applications. The maximum dissipation the device can handle is given by:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{R_{\theta JA}}$$

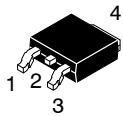
Referring to the thermal table on page 2 the appropriate  $R_{\theta JA}$  for the circuit board can be selected.

**AC Applications**

The CCR is a DC device; however, it can be used with full wave rectified AC as shown in application notes AND8433/D and AND8492/D and design notes DN05013/D and DN06065/D. Figure 14 shows the basic circuit configuration.



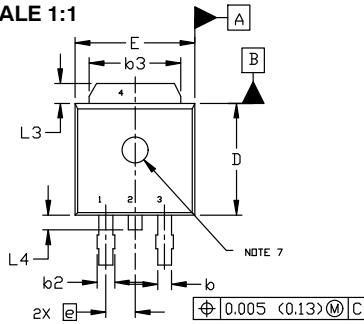
Figure 14. Basic AC Application



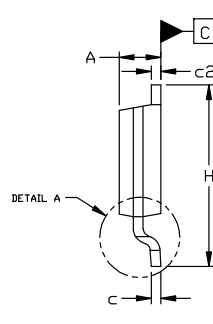
DPAK (SINGLE GAUGE)  
CASE 369C  
ISSUE G

DATE 31 MAY 2023

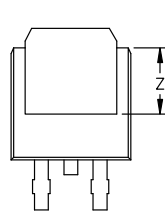
SCALE 1:1



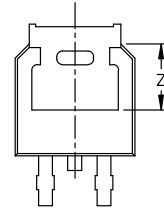
TOP VIEW



SIDE VIEW

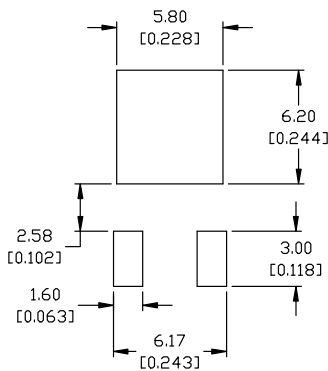


BOTTOM VIEW



BOTTOM VIEW

ALTERNATE CONSTRUCTIONS



RECOMMENDED MOUNTING FOOTPRINT\*

\*FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

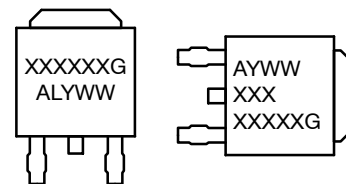
- STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR
- STYLE 2:  
PIN 1. GATE  
2. DRAIN  
3. SOURCE  
4. DRAIN
- STYLE 3:  
PIN 1. ANODE  
2. CATHODE  
3. ANODE  
4. CATHODE
- STYLE 4:  
PIN 1. CATHODE  
2. ANODE  
3. GATE  
4. ANODE
- STYLE 5:  
PIN 1. GATE  
2. ANODE  
3. CATHODE  
4. ANODE
- STYLE 6:  
PIN 1. MT1  
2. MT2  
3. GATE  
4. MT2
- STYLE 7:  
PIN 1. GATE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR
- STYLE 8:  
PIN 1. N/C  
2. CATHODE  
3. ANODE  
4. CATHODE
- STYLE 9:  
PIN 1. ANODE  
2. CATHODE  
3. RESISTOR ADJUST  
4. CATHODE
- STYLE 10:  
PIN 1. CATHODE  
2. ANODE  
3. CATHODE  
4. ANODE

NOTES:

1. DIMENSIONING AND TOLERANCING ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES
3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3, AND Z.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.
7. OPTIONAL MOLD FEATURE.

DIM	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
A	0.086	0.094	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.025	0.035	0.63	0.89
b2	0.028	0.045	0.72	1.14
b3	0.180	0.215	4.57	5.46
c	0.018	0.024	0.46	0.61
c2	0.018	0.024	0.46	0.61
D	0.235	0.245	5.97	6.22
E	0.250	0.265	6.35	6.73
e	0.090	BSC	2.29	BSC
H	0.370	0.410	9.40	10.41
L	0.055	0.070	1.40	1.78
L1	0.114	REF	2.90	REF
L2	0.020	BSC	0.51	BSC
L3	0.035	0.050	0.89	1.27
L4	----	0.040	---	1.01
Z	0.155	----	3.93	---

GENERIC MARKING DIAGRAM\*



- IC
- Discrete
- XXXXXX = Device Code
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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